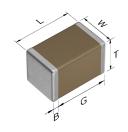
积层贴片陶瓷片式电容器

C2012X6S1A685K125AB

RoHS Reach Halogen Free Pb Free

交货型号	C2012X6S1A685KT****
用途	一般等级
特点	General 一般(~75V)
系列	C2012 [EIA 0805]
状态	▲ 量产体制(新设计非推荐)



尺寸			
长度(L)	$2.00 \text{mm} \pm 0.20 \text{mm}$		
宽度(W)	1.25 mm ± 0.20 mm		
厚度(T)	1.25 mm ± 0.20 mm		
端子宽度(B)	0.20mm Min.		
端子间隔(G)	0.50mm Min.		
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)		
1世存/杆益/11/回 (FM)	0.90mm to 1.20mm(Reflow Soldering)		
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)		
]世存/杆血/印/印 (LD)	0.70mm to 0.90mm(Reflow Soldering)		
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)		
7世代が1世7月月1日(10)	0.90mm to 1.20mm(Reflow Soldering)		

······································	气特性
电容	6.8 μF ±10%
额定电压	10VDC
温度特性	$X6S(\pm 22\%)$
耗散因数(Max.)	10%
绝缘电阻 (Min.)	14ΜΩ

	其他	
焊接方法	流体	
汗 依万亿	回流	
AEC-Q200	NO	
包装形式	塑封编带(180mm卷筒)	
包装个数	2000pcs	

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.



RoHS Reach Halogen Free Pb Free



特性图表(这是参考数据,并不保证产品的特性。)

[!] Images are for reference only and show exemplary products.

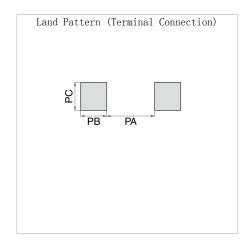
[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

RoHS Reach Halogen Free Pb Free



Associated Images



[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.